



## Material declaration form

General Information			
IPC	1752	Version	2
Form type*	Distribute		
Sectionals*	Material information	Subsectionals*	A-D
	Manufacturing information		*: Required Field

Supplier Information			
Company name*	STMicroelectronics	Response Date*	2024-07-24
Contact name*	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact phone*	Refer to Supplier Comment section	Contact email*	Refer to Supplier Comment section
Authorized representative*	Antonella Lanzafame	Representative title	AMSMaterial Declaration champion
Representative phone*	Refer to Supplier Comment section	Representative email*	Refer to Supplier Comment section
Supplier comment	Online Technical Support - STMicroelectronics : <a href="http://www.st.com/web/en/support/support.html">http://www.st.com/web/en/support/support.html</a>		

**Uncertainty statement**

While STMicroelectronics has endeavored to provide information which is accurate and up to date, this document and its contents are provided on a strict 'as is' and 'as available' basis. STMicroelectronics disclaims all warranties, express or implied related to this document and its contents, including but not limited to implied warranties of completeness, truth, accuracy, merchantability, fitness for a particular purpose and non-infringement. ST shall have no responsibility and assumes no liability for any cost, loss or damage of any kind which could arise, directly or indirectly, from the use or inability to use this document and/or its contents.

**Legal statement**

Supplier acceptance*	true	Legal declaration*	Standard
Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.			



Product				
Mfr item number	Mfr item name	Version	Manufacturing site	date
TS3121AICT	IYW8*VB4JABJ	A	ZS1A	2024-07-24
	Amount	Unit of measure	Unit type	ST ECOPACK grade
	6	mg	Each	ECOPACK® 3

Manufacturing information			
J-STD-020 MSL rating	Classification temperature	Number of reflow cycles	
1	260	3	
Bulk solder termination	Terminal plating	Terminal base alloy	Comment
Not Applicable	Nickel/Palladium/Gold (Ni/Pd/Au)	Copper Alloy	0

Comment W8 SOT 323 5LDS ; MD valid aslo for CP: TS3121AIYCT;

QueryList : RoHS Directive 2011/65/EU- 8 June 2011 – Annex II amended by Delegated Directive 2015/863 - 31 March 2015		Response
1 - Product(s) meets EU RoHS requirement without any exemptions		TRUE
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)		false
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions		false
Exemption Id.	Description	

QueryList : ELV directive : 2000/53/EC amended 2020/363 _March 2020		Response
1 - Product(s) meets EU ELV requirements without any exemptions		true
2 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
Exemption Id.	Description	

QueryList : California Prop65 list, dated 29th December 2023			Response
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen			FALSE
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen			TRUE
Substance	amount in product (mg)	Application	ppm in product
Nickel	0.022	alloy	3667

QueryList :Customer	Response
QUERY	Response

QueryList : Chinese RoHS , references : SJT 11364 – 2014 and GBT 26572 – 2014					Response
QUERY					Response
1 - Product(s) requires marking for the presence of restricted substances and must be marked with an Environmental Protection Use Period under China's Measures for Administration of the control of pollution by Electronic Information Products					false
2 - Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products					false
Hazardous substance					
Lead (Pb)	Cadmium (Cd)	Mercury (Hg)	Hexavalent Chromium (Cr VI)	PBB & PBDE	
0	0	0	0	0	0

QueryList : REACH-27th June 2024				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product
	0			
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	Amount in embedded article / Homogeneous material (mg)	Application - article / Homogeneous material	ppm in article /Homogeneous material



QueryList : Responsible metals sourcing	Response
The component is containing at least one of the following metals : Cobalt , Gold , Tantalum , Tin , Tungsten.	true
The following metals are present is the component :	Gold, Tungsten,

QueryList : Korea Chemical Control Act_ 27 Dec 2017 update	Response
The Product does contain at least one of the substances listed in Chemical Control Act	false

QueryList : China GB 33372-2020 Limit standard for volatile organic compounds content in adhesives - 4 March 2020 application date 1st December 2020	Response
The product contains adhesives identified under GB 33372	false

Stockholm Convention Persistent Organic Pollutants	Response
Product is compliant with Stockholm Convention Persistent Organic Pollutants Annex I	true

QueryList : EUSRR Directive	Response
Product contains hazardous materials listed in EUSRR Annex II	TRUE

PFAS/PTFE Declaration	Response
<b>QUERY</b>	<b>Response</b>
The product is containing at least one of the following PFAS substance: Polytetrafluoroethylene,Thiophenium, Triphenylsulfonium nonaflate, Trifluoroacetic anhydride	False

BPA Declaration	Response
Product does not contain Bisphenol A (Isopropylidenediphenol)	True

Montreal Protocol	Response
Product does not contain Ozone Depleting Substances based on Annex I to Annex VII of EU REGULATION (EC) No 1005/2009	True

Environmental Protection Agency:Toxic Substances Control Act (TSCA). Section 6(h)	Response
Product does not contain Phenol, isopropylated, phosphate (3:1)	True



Material Composition Declaration :						Mfr Item Name	IYW8*VB4JABJ	6.0000	#N/A	1000003.0		
note : Substance present with less 0.001mg will not be declared in this document												
Homogeneous material	Material group	Mass	Unit of measure	Level	Substance category	Substance	CAS	Exempt	Mass	Unit of measure	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die	M-011 Other inorganic materials	0.368	mg	supplier	die	Silicon(Si)	7440-21-3		0.348	mg	945652	58000
				supplier	metallisation	Aluminium(Al)	7429-90-5		0.004	mg	10870	667
				supplier	metallisation	Titanium(Ti)	7440-32-6		0.001	mg	2717	167
				supplier	metallisation	Tungsten(W)	7440-33-7		0.004	mg	10870	667
				supplier	Passivation	Silicon nitride(SiN)	12033-89-5		0.001	mg	2717	167
				supplier	passivation	Silicon oxide	7631-86-9		0.010	mg	27174	1667
Leadframe	M-004 Copper and its alloys	1.950	mg	supplier	alloy	Copper (Cu)	7440-50-8		1.878	mg	963077	313000
				supplier	alloy	Iron (Fe)	7439-89-6		0.043	mg	22051	7167
				supplier	alloy	Phosphorus (P)	12185-10-3		0.001	mg	513	167
				supplier	alloy	Zinc (Zn)	7440-66-6		0.003	mg	1538	500
				supplier	alloy	Nickel (Ni)	7440-02-0		0.022	mg	11282	3667
				supplier	alloy	Palladium (Pd)	7440-05-3		0.002	mg	1026	333
Die attach	M-011 Other inorganic materials	0.118	mg	supplier	glue	Silver (Ag)	7440-22-4		0.094	mg	796610	15667
				supplier	glue	Isobornyl Methacrylate	7534-94-3		0.010	mg	84746	1667
				supplier	glue	methylene diacrylate	42594-17-2		0.007	mg	59322	1167
				supplier	glue	Urethane Methacrylate Resin	5888-33-5		0.006	mg	50847	1000
					glue	Bis(α,α-dimethylbenzyl) peroxide	80-43-3		0.001	mg	8475	167
				supplier	wire	Gold (Au)	7440-57-5		0.024	mg	1000000	4000
Bonding wires	M-008 Precious metals	0.024	mg	supplier	wire	Gold (Au)	7440-57-5		0.024	mg	1000000	4000
				supplier	wire	Gold (Au)	7440-57-5		0.024	mg	1000000	4000
Encapsulation	M-011 Other inorganic materials	#N/A	mg	supplier	mold compound	Silica, vitreous	60676-86-0		3.023	mg	#N/A	503833
				supplier	mold compound	phenolic resin	Proprietary		0.111	mg	#N/A	18500
				supplier	mold compound	epoxy resin	Proprietary		0.213	mg	#N/A	35500
				supplier	mold compound	Biphenyl epoxy resin	85954-11-6		0.185	mg	#N/A	30833
				supplier	mold compound	carbon black	1333-86-4		0.008	mg	#N/A	1333